138—174, 406—512 MHz OSCILLATOR-MULTIPLIER BOARD 19C321981G1-6 138—174 MHz ADAPTER BOARD 19B227258G1 406—512 MHz MULTIPLIER BOARD 19C321998G1, 2

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DESCRIPTION

The Oscillator-Multiplier board for the General Electric CUSTOM MVP radio is used in the 138-174 MHz and 406-512 MHz frequency bands. In addition to the oscillator-multiplier board, an adapter board is required on 138-174 MHz applications or a multiplier board in 406-512 MHz applications to complete the oscillator-multiplier chain to the mixer or IF filter boards.

The oscillator-multiplier board (Osc-Mult) contains a Colpitts oscillator, two multiplier stages and an amplifier. The operating frequency of the Colpitts oscillator is maintained within ±5 PPM by an externally compensated crystal module. The crystal frequencies range from approximately 14 to 18 megahertz and are multiplied nine times in the 138-174 MHz frequency band and 27 times in the 406-512 MHz frequency band to provide a low side injection frequency to the mixer.

CIRCUIT ANALYSIS

F1 OSCILLATOR CIRCUIT

Transistor Q402, a plug-in crystal module, trimmer capacitor, varicap and associated components comprise a Colpitts oscillator operating at the assigned Fl receive frequency.

The crystal module, located in the base circuit of Q402, is temperature compensated to maintain frequency stability over a temperature range of -30°C to +60°C. Compensation voltage from the exciter is applied through P602-1 to pin four of the crystal modules.

The compensation voltage varies nonlinearly with temperature to complement the temperature-frequency characteristics of the crystal. Listed below are typical minimum and maximum voltage readings to be expected at pin 4 of the crystal modules, as measured with a high impedance meter.

TEMPERATURE	OUTPUT VOLTAGE		
RANGE	MINIMUM	MAXIMUM	
-30°C -10°C to +50°C	4.9 Volts	6.0 Volts 4.3 Volts	
+75°C	3.3 Volts	3.8 Volts	

Trimmer capacitor C3 is used to adjust the radio for the exact operating frequency. Refer to the Alignment Procedure for details.

Refer to the System Maintenance Manual for circuit details of the crystal modules.

- SERVICE NOTE -

Y1 and C2 are not field replaceable items. C2 is factory selected to complement the temperature/frequency characteristics of each individual crystal. Should it become necessary to replace either Y1 or C2, the entire crystal module must be replaced.

In single frequency applications, the F1 keying lead is wired to A- by a DA jumper wire connected between H8 and H9.

In multi-frequency radios this jumper is removed to allow Fl frequency selection via the frequency selector switch on the control panel.



With the radio turned on and the PTT switch released, +10 V is present on the Rx OSC control lead at P602-6 and the oscillator operates at the crystal frequency. Capacitor C402 provides the necessary inphase feedback to sustain oscillations. Avoltage divider network consisting of R407 and R408 sets the bias for oscillator transistor Q402.

C406 is tuned to three times the crystal frequency. The output of the tuned circuit is applied to the base of Class C multiplier Q403. The collector tank circuit of the multiplier (L402, C411, and C412) is tuned to nine times the crystal frequency. The output of the multiplier stage is metered across R411 and applied to receiver metering jack J601 through P602-3.

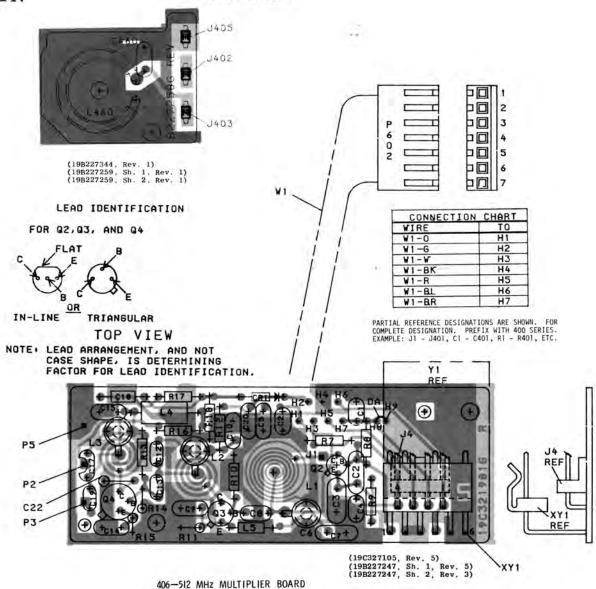
Following the multiplier is a Class A Amplifier stage, Q404. The output of Q404 is metered through a metering network consisting of C418, C420, CR401, R417 and R418 and applied to receiver metering jack J601 through P602-4. The amplifier output of Q404 is applied to a tuned circuit (L403 and C416) that is tuned to nine times the crystal frequency. The tuned circuit provides additional selectivity in the oscillator-multiplier chain.

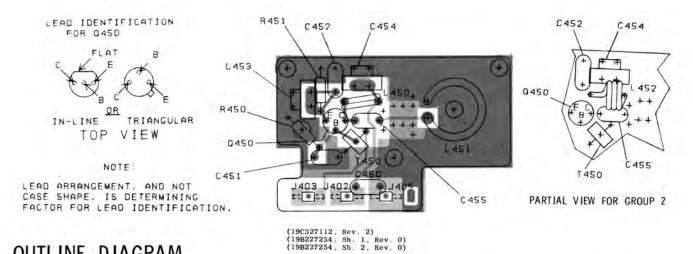
In 138-174 MHz applications, the output of the oscillator-multiplier is coupled through C419 to the adapter board. The output of the adapter board is inductively coupled through L460 and two helical resonators on the RF assembly to the input of the mixer stage.

In 406-512 MHz applications, the output of the oscillator-multiplier is coupled through C419 to the base of Class C multiplier Q450 through a matching network (T450 and C451). The output of Q450 is inductively coupled to the first of three helical resonators through L451. The helicals are tuned to 27 times the crystal frequency by C306, C307, and C308. Most of the selectivity for the oscillator-multiplier chain is provided by the three high-Q helicals. The output of the helicals is applied to the source of mixer FET Q1 on the mixer board. The multiplier output is metered at J601-7 through a metering network on the IF-Filter board. The metering network consists of L505, L506, C512, C513, C514, CR501, and

GENERAL ELECTRIC COMPANY+ MOBILE COMMUNICATIONS DIVISION WORLD HEADQUARTERS+LYNCHBURG, VIRGINIA 24502 U.S.A.





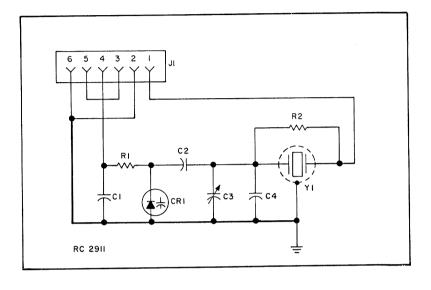


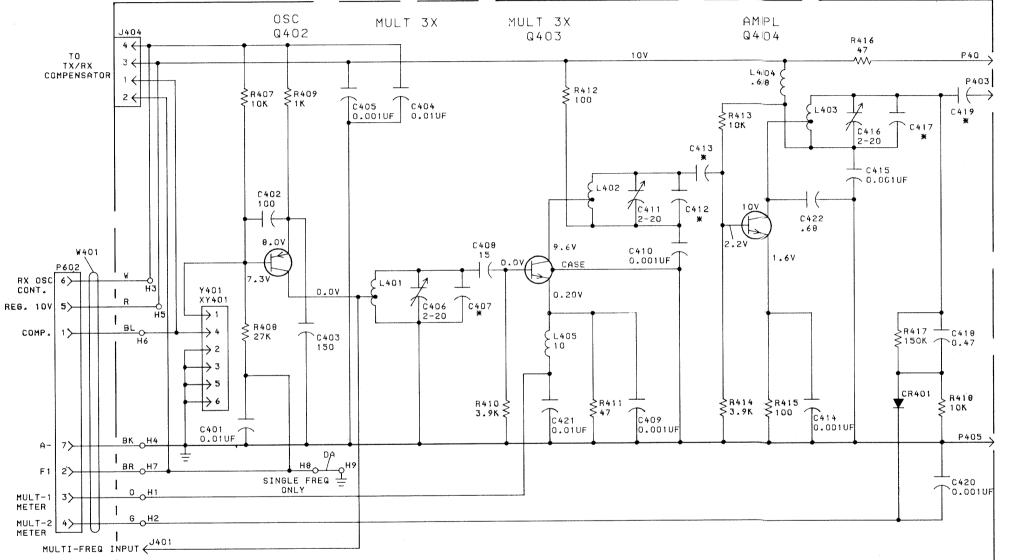
OUTLINE DIAGRAM

138-174 & 406-512 MHz OSCILLATOR-MULTIPLIER

RUNS ON SOLDER SIDE RUNS ON BOTH SIDES RUNS ON COMPONENT SID

TYPICAL CRYSTAL MODULE





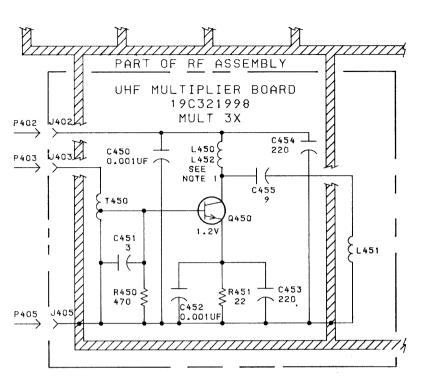
ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K-1000 OHMS OR MEG-1,000,000 OHMS. CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF-MICROFARADS.

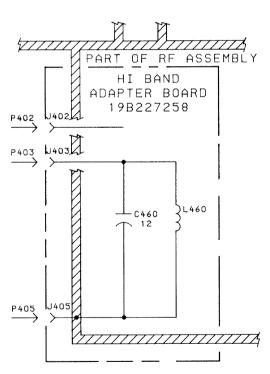
NOTES: 1. L450-GROUP 1, L452-GROUP 2.

	IREV	FREU	
	LETTER	RANGE	MHZ
OSC/MULT BD			
19C321981G1	E	406-42	20
19C321981G2	E	420-4	70
19C321981G3	E	470-49	94
19C321981G4	E	494-5	12
19032198165	E	138-15	55
19032198166	E	150.8	-174
MULT BD			
19C321998G1		450-5	12
19C321998G2		406-4	50
ADAPATER BD			
19B227259G1		138-1	74

*COMP(*COMPONENT VALUE TABLE FOR OSCILLATOR/MULTIPLIER					ER
COMPONENT	406-420	420-470	470-494	494-512	138-155	150-174
DESIGNATION	MHZ	MHZ	MHZ	MHZ	MHZ	MHZ
	LL	L&LM	М	Н	LA	HA
C407	27	20	18	15	24	18
C412	8	3	3	OMIT	5	OMIT
C413	5	5	5	4	5	5
C417	4	OMIT	-	-	OMIT	-
C419	5	5 .	5	5	5	3

VOLTAGE READINGS VOLTAGE READINGS ARE TYPICAL READINGS MEASURE® TO SYSTEM NEGATIVE (P03-6) WITH TEST SET MODEL 4EX3A11 OR A 20,000 OHM-PER-VOLT METER.





SCHEMATIC DIAGRAM

138—174 & 406—512 MHz OSCILLATOR-MULTIPLIER

PARTS LIST

LBI30153F

138-174, 406-512 MHz

SYMBOL	GE PART NO.	DESCRIPTION
		19C321981G1 406-420 MHz (LL) 19C321981G2 420-470 MHz (L) 19C321981G3 470-494 MHz (M) 19C321981G4 494-512 MHz (H) 19C321981G5 138-155 MHz (LA) 19C321981G6 150.7-174 MHz (HA)
401	19A700234P7	Polyester: 0.01 uF ±10%, 50 VDCW.
02	5496218P763	Ceramic disc: 100 pF ±5%, 500 VDCW, temp coef -750 PPM.
103	19A700105P38	Mica: 150 pF ±5%, 500 VDCW.
04	19A700234P7	Polyester: 0.01 uF ±10%, 50 VDCW.
)5	19A143481P19	Ceramic: 1000 pF ±20%, 1000 VDCW.
06	19A700012P2	Variable, ceramic: 2.5 to 20 pF 200 VDCW, temp coef -250 -700 PPM; sim to Panasonic ECX1ZW20X32.
7LL	19A143491P27J0	Ceramic: 27 pF ±5%, temp coef 0 PPM.
7L	19A143491P20J0	Ceramic: 20 pF ±5%, temp coef 0 PPM.
7M	19A143491P18J0	Ceramic: 18 pF ±5%, 500 VDCW, temp coef 0 PPM.
97H	19A143491P15J0	Ceramic: 15 pF ±5%, temp coef 0 PPM.
7LA 7HA	19A143491P24J0 19A143491P18J0	Ceramic: 24 pF ±5%, 500 VDCW, temp coef 0 PPM. Ceramic: 18 pF ±5%, 500 VDCW, temp coef 0 PPM.
	19A143491P18J0	Ceramic: 15 pF ±5%, temp coef 0 PPM.
	19A143481P19	Ceramic: 1000 pF ±20%, 1000 VDCW.
0	19A700012P2	Variable, ceramic: 2.5 to 20 pF 200 VDCW, temp coef -250 -700 PPM; sim to Panasonic ECX1ZW20X32.
2LL*	19A143491P8J0	Ceramic: 8 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM In REV C & earlier:
	19A116656P12J0	Ceramic disc: 12 pF ±5%, 500 VDCW; temp coef 0 PPM.
2L*	19A143491P3J0	Ceramic: 3 pF ±0.5 pF, temp coef 0 PPM. In REV C & earlier:
	19A116656P6J0	Ceramic disc: 6 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM.
12 M*	19A143491P3J0	Ceramic: 3 pF ±0.5 pF, temp coef 0 PPM. In REV C & earlier:
	19A116656P5J0	Ceramic disc: 5 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM.
.2H*	19A116656P4J0	Ceramic disc: 4 pF +0.5 pF, 500 VDCW, temp coef 0 PPM. Deleted by REV C.
2LA*	19A143491P5J0	Ceramic: 5 pF \pm 0.5 pF, 500 VDCW, temp coef 0 PPM In REV C & earlier:
	19A116656P8J0	Ceramic disc: 8 pF ±0.5 pF, 500 VDCW; temp coef 0 PPM.
2HA*	19A116656P5J0	Ceramic disc: 5 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM. Deleted by REV B.
3*	19A116656P5J0	Ceramic disc: 5 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM.
	19A116656P3J0	In REV C & earlier: Ceramic disc: 3 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM.
13H*	19A143491P4J0	Ceramic: 4 pF ±0.5 pF, temp coef 0 PPM. Added by REV D.
14 d 15	19A143481P19	Ceramic: 1000 pF ±20%, 1000 VDCW.

SYMB0L	GE PART NO.	DESCRIPTION	SYMBOL
C416	19A700012P2	Variable, ceramic: 2.5 to 20 pF 200 VDCW, temp	R412
041711*	19A143491P4J0	coef -250 -700 PPM; sim to Panasonic ECX1ZW20X32.	R413
C417LL*	1941434919450	Ceramic: 4 pF ±0.5 pF, temp coef 0 PPM. In REV C & earlier:	R414
	19A116656P7J0	Ceramic disc: 7 pF ±0.5 pF, 500 VDCW, temp coef	R415
		О РРМ.	R416
C417L*	19A116656P3J0	Ceramic disc: 3 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM. Deleted by REV D.	R417 R418
C417LA*	19A116656P3J0	Ceramic disc: 3 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM. Deleted by REV D.	N 110
C418	5491601P13	Phenolic: 0.47 pF ±10%, 500 VDCW.	W401
C419LL	19A143491P5J0	Ceramic: 5 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM	
C419L	19A143491P5J0	Ceramic: 5 pF +0.5 pF, 500 VDCW, temp coef 0 PPM	
C419M	19A143491P5J0	Ceramic: 5 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM	XY401
C419H	19A143491P5J0	Ceramic: 5 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM	£.
C419LA	19A143491P5J0	Ceramic: 5 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM	
C419HA*	19A143491P3J0	Ceramic: 3 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM In REV A & earlier:	
	19A116656P5J0	Ceramic disc: 5 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM.	
C420	19A143481P19	Ceramic: 1000 pF +20%, 1000 VDCW.	
C421	19A700234P7	Polyester: 0.01 uF ±10%, 50 VDCW.	Y401
C422*	19A700013P11	Phenolic: 0.68 pF ±5%, 500 VDCW. Added by REV A.	
		DIODES AND RECTIFIERS	
CR401	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.	
		JACKS AND RECEPTACLES	
J401	19A701785P1	Contact, electrical; sim to Molex 08-50-0404.	
J404	19A116659P118	Connector, printed wiring: 4 contacts; sim to	
		Molex 09-88-2041.	C2311
		INDUCTORS	
L401 thru L403		(Part of printed board 19C331431P1).	C2312
L404	19A700000P10	Coil, RF: 680 nH ±10%; sim to Jeffers 4411-6K.	C2313
L405	19A700024P25	Coil, RF: 10.0 uH ±10%, 3.70 ohms DC res max.	C2314
			C2318
P402	19A701785P3	Contact, electrical.	02010
and P403	10.110110	00000000, 01000110011	C2304
P405	19A701785P3	Contact, electrical.	
P602		(Part of W401).	L2301
		TRANSISTORS	
Q402	19A115852P1	Silicon, PNP; sim to Type 2N3906.	
Q403*	19A134670P1	Silicon, NPN.	
•		In REV B & earlier:	
	19A115440P1	Silicon, NPN.	Y401
Q404*	19A116899P1	Silicon, NPN.	
		In REV D & earlier:	
	19A115329P2	Silicon, NPN.	
		RESISTORS	
R407	19A700106P87	Composition: 10K ohms ±5%, 1/4 w.	
R408	19A700106P97	Composition: 7K ohms ±5%, 1/4 w.	Y401
R409	19A700106P63	Composition: 1K ohms ±5%, 1/4 w.	
R410	19A700106P77	Composition: 3.9K ohms ±5%, 1/4 w.	4
R411	19A700106P31	Composition: 47 ohms ±5%, 1/4 w.	

DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
Composition: 100 ohms ±5%, 1/4 w.			138-174 MHz ADAPTER BOARD
Composition: 10K ohms $\pm 5\%$, 1/4 w.			19B227258G1
Composition: 3.9K ohms ±5%, 1/4 w.			
Composition: 100 ohms ±5%, 1/4 w.	C460*	19A116656P12K0	'Ceramic disc: 12 pF ±10%, 500 VDCW; temp coef 0 pPM.
Composition: 47 ohms ±5%, 1/4 w. Composition: 150K ohms ±5%, 1/4 w.			Earlier than REV A:
Composition: 10K ohms ±5%, 1/4 w.		19A116656P18K0	Ceramic disc: 18 pF ±10%, 500 VDCW, temp coef 0 pPM.
Cable. Includes: (P602) 19A116659P82.			JACKS AND RECEPTACLES
	J402 and	19A701883P4	Contact, electrical; sim to AMP 86444-1. (Strip Form).
	J403 J405	19A701883P4	(Outliet alouted aloue to the NR COLLEGE COLLEGE
Connector: 6 terminals.	1405	194701883P4	Contact, electrical; sim to AMP 86444-1. (Strip Form).
ASSOCIATED ASSEMBLIES			
	L460	19A129280P1	Coil.
NOTE: When reordering, give GE Part Number and specify exact operating frequency needed.			406-512 MHz MULTIPLIER BOARD 19C321998G1 420-512 MHz 19C321998G2 406-420 MHz
For Standard Low Side Injection Frequency.			
Rx. 5 PPM. (138-155 MHz).			
Rx. 5 PPM. (150.8-174 MHz). NOTE: For High Side Injection Frequency Using	C450	19A116655P19	Ceramic disc: 1000 pF ±20%, 1000 VDCW; sim to RMC Type JF Discap.
High Side Modification Kit 19A130045G1.	C451	19A116656P3K0	Ceramic disc: 3 pF ±1 pF, 500 VDCW, temp coef 0 PPM.
Rx. 5 PPM. (138-155 MHz). Rx. 5 PPM. (150.8-174 MHz).	C452	19A116655P19	Ceramic disc: 1000 pF ±20%, 1000 VDCW; sim to RMC Type JF Discap.
HIGH SIDE INJECTION MODIFICATION KIT 19A130045G2	C453 and C454	19A116679P220K	Silver Mica: 220 pF ±10%, 250 VDCW.
	C455	19A116656P9K0	(Ceramic disc: 9 pF ±1 pF, 500 VDCW; temp coef 0 PPM.
Ceramic disc: 12 pF ±10%, 500 VDCW; temp coef 0 PPM.			
Ceramic disc: 3 pF ±0.5 pF, 500 VDCW, temp coef	J402	19A701883P4	Contact, electrical; sim to AMP 86444-1. (Strip
0 PPM.	and J403		Form).
Ceramic disc: 5 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM.	J405	19A701883P4	Contact, electrical; sim to AMP 86444-1. (Strip Form).
Ceramic disc: 4 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM.			
Ceramic disc: 10 pF ±5%, 500 VDCW; temp coef -80 PPM.	L450	19A129711P1	Coil.
Polyester: 0.01 uF ±10%, 50 VDCW.	L451	19A129710P1	Coil.
	L452	19A129352P8	Coil.
Coil, RF: 330 nH ±10%.			
	Q450	19A116201P1	Silicon, NPN.
NOTE: When reordering, give GE Part Number and			RESISTORS
specify exact operating frequency needed.	R450	19A700106P55	Composition: 470 ohms +5%, 1/4 w.
For Standard Low Side Injection Frequency.	R451	19A700106P23	Composition: 22 ohms ±5%, 1/4 w.
Crystal module: 5 PPM, 406-420 MHz.			
Crystal module: 5 PPM, 420-450 MHz.	T450	19A129920G1	
Crystal module: 5 PPM, 450-470 MHz. Crystal module: 5 PPM, 470-494 MHz.	1 ****	10012002001	Coil.
Crystal module, 5 PPM, 494-512 MHz.			
mile.		4031594P1	Insulator, telfon. (Used with C6, C11, C16).
For High Side Injection Frequency:		,	
Crystal module: 5 PPM, 406-420 MHz.			
Crystal module: 5 PPM, 420-450 MHz.			
Crystal module: 5 PPM, 450-470 MHz.			
Crystal module: 5 PPM, 470-494 MHz.			
Crystal module: 5 PPM, 494-512 MHz.	1		

GE PART NO.

19A700106P39

19A700106P87

19A700106P77

19A700106P39

19A700106P31

3R152P154J

19A700106P87

19B226965G2

19A136694G1

19B226962G13

19B226962G14

19B226962G19

19B226962G20

19A116656P12K0 19A116656P3JO

19A116656P5J0

19A116656P4J0 19A116656P10J8

19A116080P101

19A700024P7

19B226962G15

19B226962G29

19B226962G16

19B226962G17

19B226962G18

19B226962G21

19B226962G36

19B226962G22

19B226962G23

19B226962G24

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A - Oscillator Multiplier Board 19C321981G1-6 Stop spurious oscillation in Amplifier Q404. Added C422.

REV. B - Oscillator Multiplier Board 19C321981G1-6

REV. A - <u>High Band Adapter Board 19B227258G1</u> To improve tuning at 174 MHz. Changed C419 and C460

REV. C - Oscillator Multiplier Board 19C321981G1-6 To improve reliability. Changed Q403.

REV. D - Oscillator/Multiplier Board 19C321981G1-G6 To increase oscillator output. Changed C412, C413 and C417.

REV. E - Oscillator/Multiplier Board 19C321981G1-G6 To incorporate new transistor. Changed Q404.

END OF DOCUMENT